



μPSD3200 FAMILY

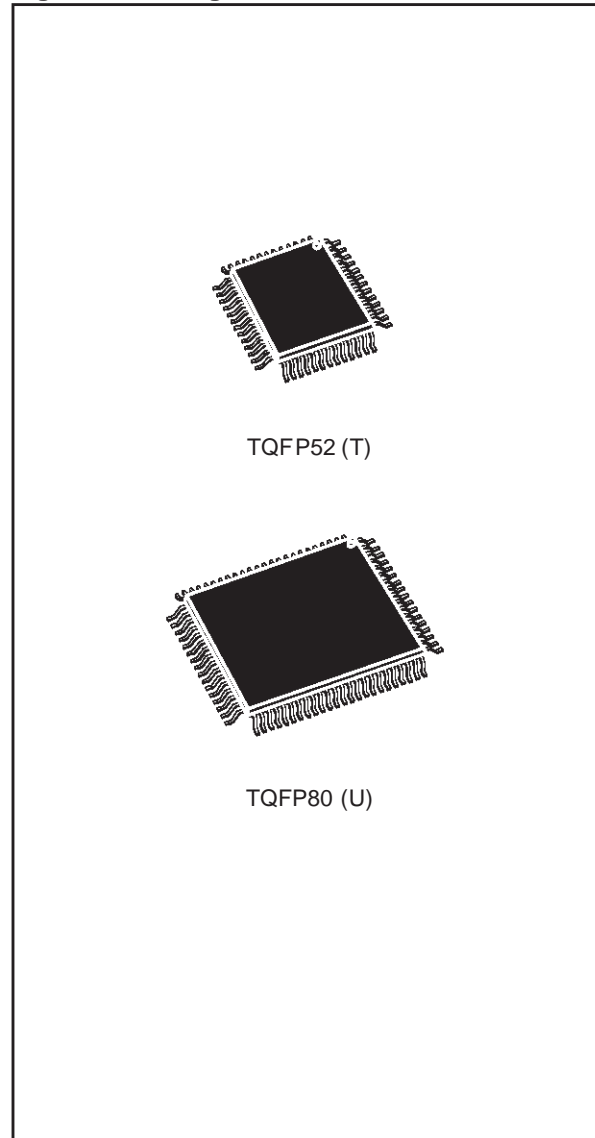
Flash Programmable System Device with 8032 Microcontroller Core

DATA BRIEFING

FEATURES SUMMARY

- The μPSD3200 Family combines a Flash PSD architecture with an 8032 microcontroller core
- The μPSD3200 Family of Flash PSDs features dual banks of Flash memory, SRAM, general purpose I/O and programmable logic, supervisory functions and access via USB, I²C, ADC, DDC and PWM channels, and an on-board 8032 microcontroller core, with two UARTs, three 16-bit Timer/Counters and one External Interrupt. As with other Flash PSD families, the μPSD3200 Family is also in-system programmable (ISP) via a JTAG ISP interface.
- Large 8 KByte SRAM with battery back-up option
- Dual bank Flash memories
 - 128 KByte or 256 KByte main Flash memory
 - 32 KByte secondary Flash memory
- Content Security
 - Block access to Flash memory
- Programmable Decode PLD for flexible address mapping of all memories.
- High-speed clock standard 8032 core (12-cycle)
- USB Interface (μPSD3234A-40U6 only)
- I²C interface for peripheral connections
- Five Pulse Width Modulator (PWM) channels
- Standalone Display Data Channel (DDC)
- Six I/O ports with up to 50 I/O pins
- 3000 gate PLD with 16 macrocells
- Supervisor functions
- In-System Programming (ISP) via JTAG
- Zero-Power Technology
- Single Supply Voltage
 - 4.5 to 5.5 V
 - 3.0 to 3.6 V

Figure 1. Packages



SUMMARY DESCRIPTION

- Dual bank Flash memories
 - Concurrent operation, read from memory one while erasing and writing the other. In-Application Programming (IAP) for remote updates
 - Large 128 KByte or 256 KByte main Flash memory for application code, operating systems, or bit maps for graphic user interfaces
 - Large 32 KByte secondary Flash memory divided in small sectors. Eliminate external EEPROM with software EEPROM emulation
 - Secondary Flash memory is large enough for sophisticated communication protocol (USB) during IAP while continuing critical system tasks
- Large SRAM with battery back-up option
 - 8 KByte SRAM for RTOS, high-level languages, communication buffers, and stacks
- Programmable Decode PLD for flexible address mapping of all memories
 - Place individual Flash and SRAM sectors on any address boundary
 - Built-in page register breaks restrictive 8032 limit of 64 KByte address space
 - Special register swaps Flash memory segments between 8032 “program” space and “data” space for efficient In-Application Programming
- High-speed clock standard 8032 core (12-cycle)
 - 40 MHz operation at 5 V, 24 MHz at 3.3 V
 - Two UARTs with independent baud rate, three 16-bit Timer/Counters and two External Interrupts
- USB Interface (μPSD3234A-40U6 only)
 - Supports USB 1.1 Slow Mode (1.5 Mbit/s)
 - Control endpoint 0 and interrupt endpoints 1 and 2
- I²C interface for peripheral connections
 - Capable of master or slave operation
- Five Pulse Width Modulator (PWM) channels
 - Four 8-bit PWM units
 - One 16-bit PWM unit
- Standalone Display Data Channel (DDC)
 - For use in monitor, projector, and TV applications
 - Compliant with VESA standards DDC1 and DDC2B
 - Eliminate external DDC PROM
- Six I/O ports with up to 50 I/O pins
 - Multifunction I/O: GPIO, DDC, I²C, PWM, PLD I/O, supervisor, and JTAG
 - Eliminates need for external latches and logic
- 3000 gate PLD with 16 macrocells
 - Create glue logic, state machines, delays, etc.
 - Eliminate external PALs, PLDs, and 74HCxx
 - Simple PSDsoft Express software ...Free
- Supervisor functions
 - Generates reset upon low voltage or watchdog time-out. Eliminate external supervisor device
 - Reset In pin
- In-System Programming (ISP) via JTAG
 - Program entire chip in 10 - 25 seconds with no involvement of 8032
 - Allows efficient manufacturing, easy product testing, and Just-In-Time inventory
 - Eliminate sockets and pre-programmed parts
 - Program with FlashLINK™ cable and any PC
- Content Security
 - Programmable Security Bit blocks access of device programmers and readers
- Zero-Power Technology
 - Memories and PLD automatically reach standby current between input changes
- Packages
 - 52-pin TQFP
 - 80-pin TQFP: allows access to 8032 address/data/control signals for connecting to external peripherals

Figure 2. μPSD3200 Family Functional Modules

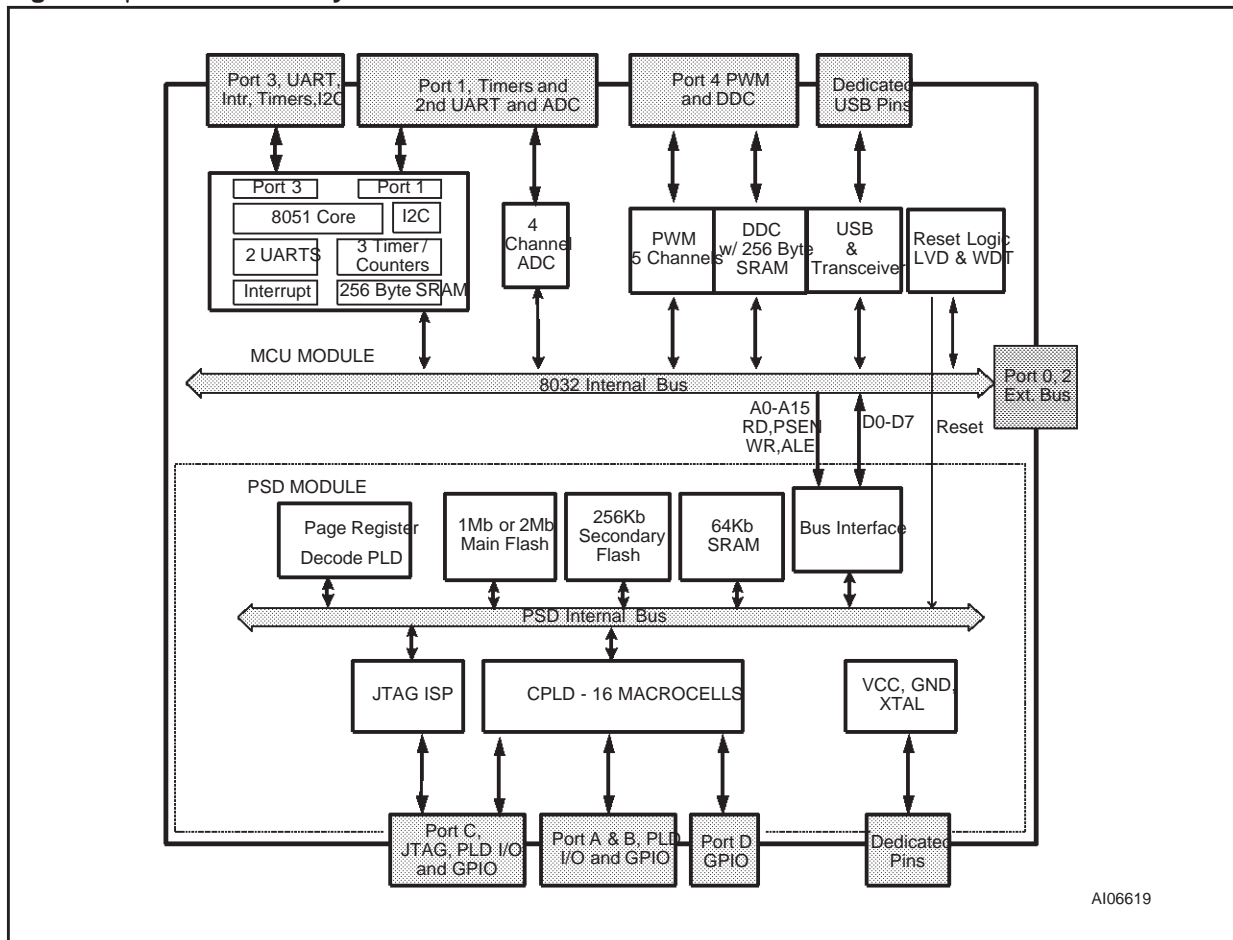
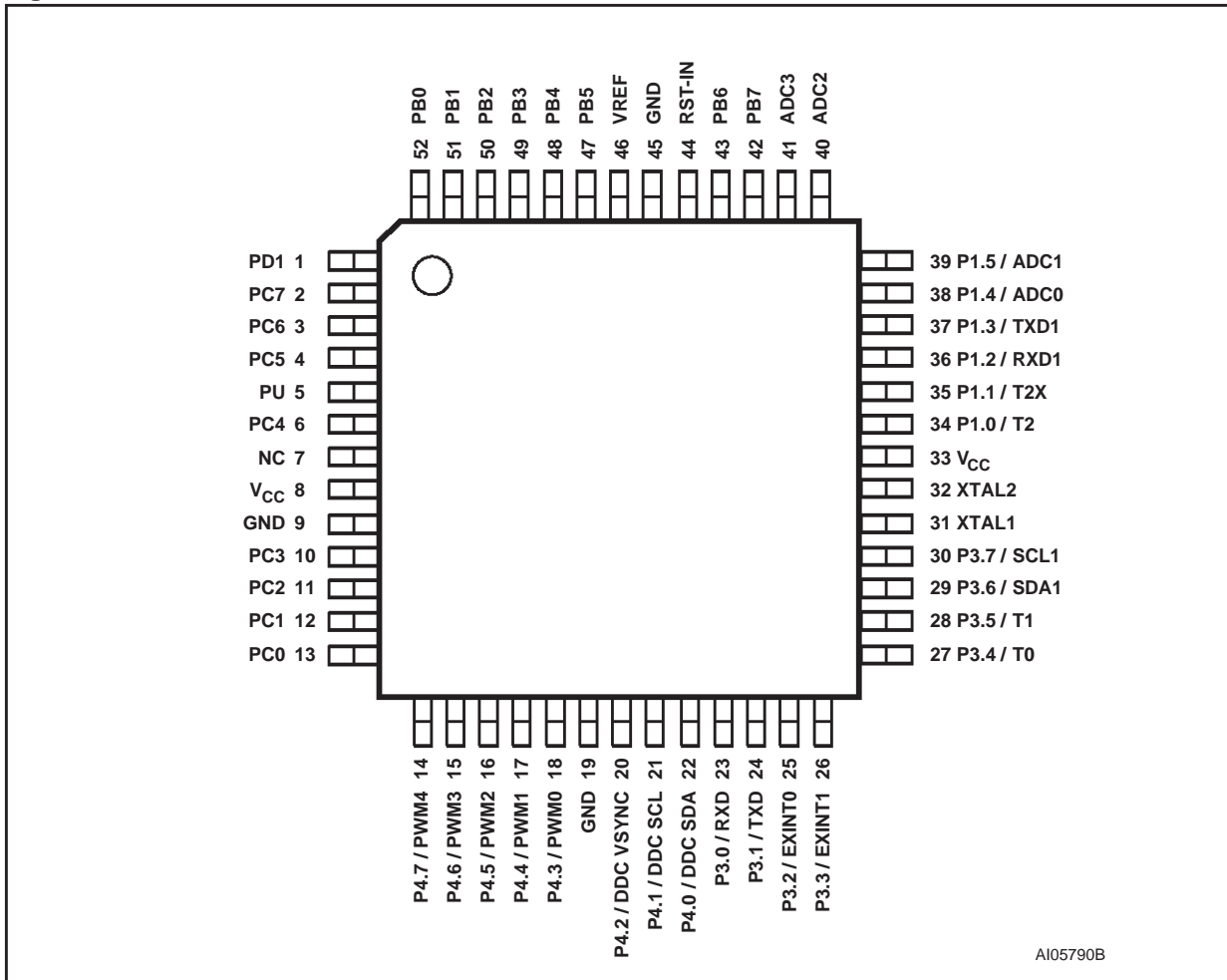


Table 1. 80-Pin Package Pin Description

Signal Name	In/Out	Function	
		Basic	Alternate
AD7-AD0	I/O	Multiplexed Address/Data bus	
A11-A8	I/O	External Address Bus	
RxD2-RxD1	I/O	General I/O port pins	UART Receive
TxD2-TxD1	I/O		UART Transmit
INT1-INT0	I/O		Interrupt inputs / timer gate controls
T2-T0	I/O		Counter inputs
SDA1-SDA2	I/O		I ² C Bus serial data I/O / DDC interface
SCL1-SCL2	I/O		I ² C Bus clock I/O
VSYNC	I/O		VSYNC input for DDC interface
T2EX	I/O		Timer 2 Trigger input
ADC3-ADC0	I/O		ADC Channels input
PWM4-PWM0	I/O		8-bit Pulse Width Modulation outputs
USB-, USB+	I/O		USB I/O
AVREF	O	Reference Voltage input for ADC	
RD_	O	Read signal, external bus	
WR_	O	Write signal, external bus	
PSEN_	O	PSEN signal, external bus	
ALE	O	Address Latch signal, external bus	
RESET_	I	Active low reset input	
XTAL1	I	Oscillator input pin for system clock	
XTAL2	O	Oscillator output pin for system clock	
PA7-PA0	I/O	General I/O port pins	1. PLD Macro-cell outputs 2. PLD inputs 3. Latched Address Out (A0-A7) 4. Peripheral I/O mode
PB7-PB0	I/O	General I/O port pins	1. PLD Macro-cell outputs 2. PLD inputs 3. Latched Address Out (A0-A7)
PC7-PC0	I/O	General I/O port pins	1. PLD Macro-cell outputs 2. PLD inputs 3. SRAM stand by voltage input (VSTBY) 4. JTAG Interface (TDI, TDO, TMS, TCK, TSTAT, TERR) 5. SRAM battery-on indicator (PC4)
PD2-PD1	I/O	General I/O port pin	1. PLD I/O 2. Clock input to PLD and APD 3. Chip select to PSD Module

Note: PSD Port A and MCU Address/Data bus are added for 80-pin device

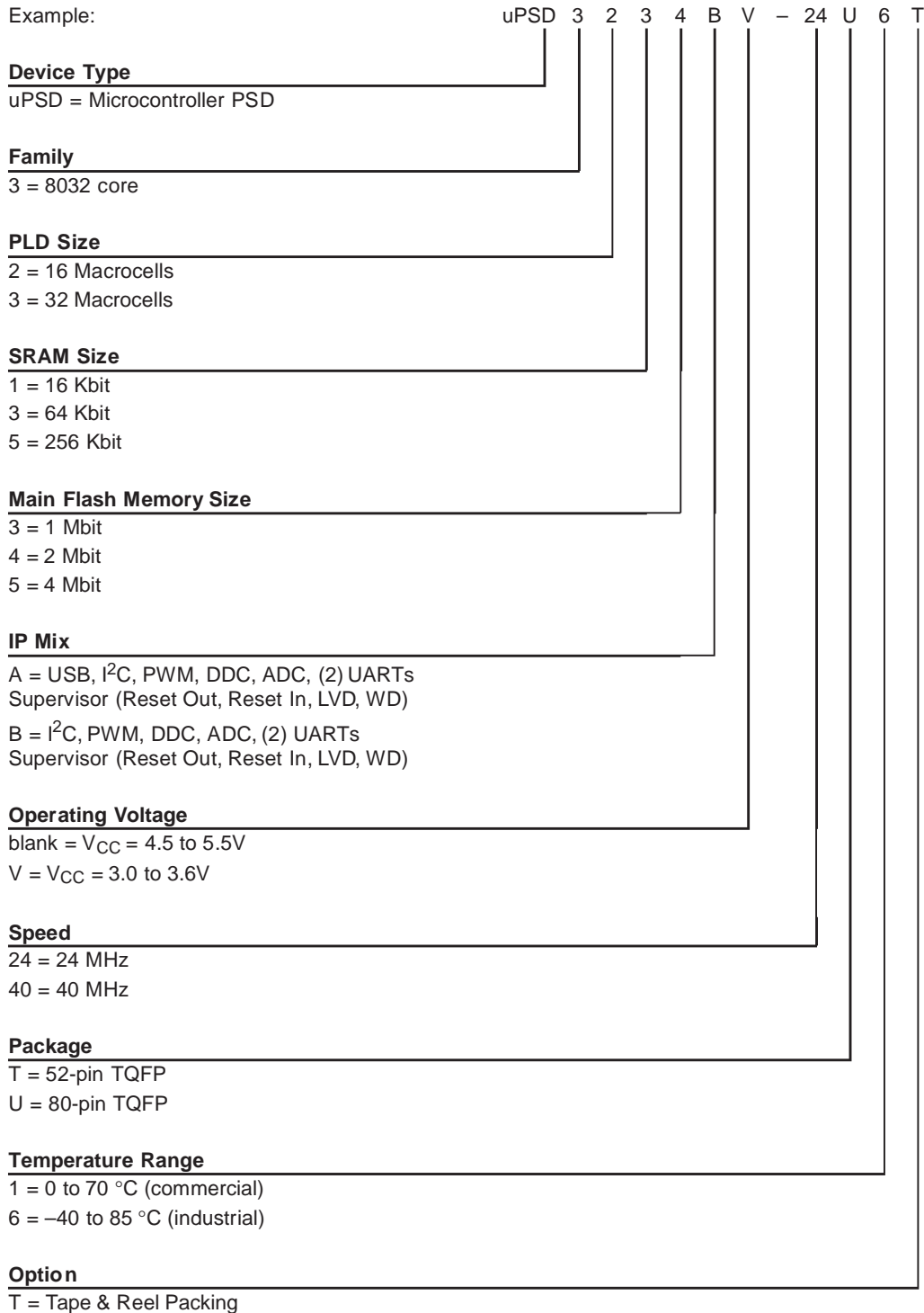
Figure 3. TQFP52 Connections



Note: NC = Not Connected
 PU = Pull-up resistor required (2kΩ for 3V devices, 7.5kΩ for 5V devices)

PART NUMBERING

Table 2. Ordering Information Scheme



For a list of available options (speed, package, etc.) or for further information on any aspect of this

device, please contact your nearest ST Sales Office.



Information furnished is believed to be accurate and reliable. However, STMicroelectronics assumes no responsibility for the consequences of use of such information nor for any infringement of patents or other rights of third parties which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of STMicroelectronics. Specifications mentioned in this publication are subject to change without notice. This publication supersedes and replaces all information previously supplied. STMicroelectronics products are not authorized for use as critical components in life support devices or systems without express written approval of STMicroelectronics.

The ST logo is registered trademark of STMicroelectronics
All other names are the property of their respective owners

© 2002 STMicroelectronics - All Rights Reserved

STMicroelectronics group of companies
Australia - Brazil - Canada - China - Finland - France - Germany - Hong Kong -
India - Israel - Italy - Japan - Malaysia - Malta - Morocco - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States.
www.st.com